

2N5264

NPN HIGH VOLTAGE-HIGH CURRENT TRANSISTOR

DIFFUSED SILICON PLANAR* EPITAXIAL DEVICE

- HIGH VOLTAGE 300 V $V_{CE(sat)}$, 180 V V_{CEO}
- HIGH CURRENT . . . MAX. $V_{CE(sat)}$ OF 1.25 V AT $I_C = 7.0$ A, $I_B = 0.7$ A
- HIGH SPEED MAX. t_f OF 1.0 μ s AT $I_C = 7.0$ A, $I_B = \pm 0.7$ A

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures

- Storage Temperature
- Operating Junction Temperature

Maximum Power Dissipation (Note 2)

- Total Dissipation at 25°C Case Temperature
(See Safe Operating Area)
- Junction to Case Thermal Resistance

Maximum Voltages and Currents

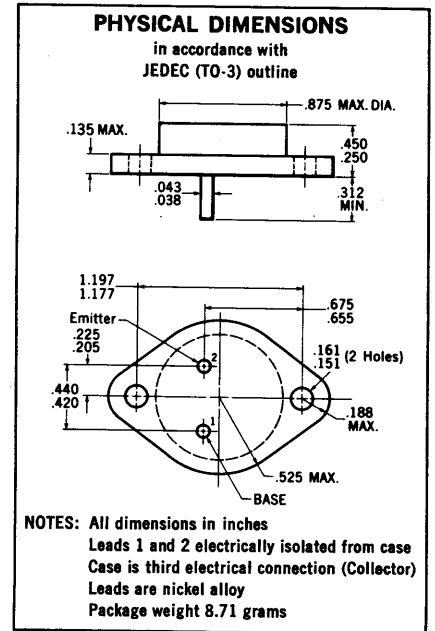
- V_{CBO} Collector to Base Voltage
- V_{CEO} Collector to Emitter Voltage
- V_{EBO} Emitter to Base Voltage
- I_C Collector Current
- I_B Base Current

-65°C to +200°C
+200°C

87 Watts

2.0°C/W

300 Volts
180 Volts
5.0 Volts
10.0 Amps
2.0 Amps



ELECTRICAL CHARACTERISTICS (25°C Case Temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
V_{CES}	Collector to Emitter Breakdown Voltage	300			Volts	$I_C = 1.0$ mA $R_{BE} = 0 \Omega$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 3)		0.60	1.25	Volts	$I_C = 7.0$ A $I_B = 0.7$ A
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 3)		1.20	1.60	Volts	$I_C = 7.0$ A $I_B = 0.7$ A
I_{CES}	Collector Cutoff Current		0.05	10	μ A	$V_{CE} = 200$ V $R_{BE} = 0 \Omega$
V_{EBO}	Emitter to Base Breakdown Voltage	5.0			Volts	$I_C = 0$ $I_E = 1.0$ mA
I_{EBO}	Emitter Cutoff Current		0.01	10	μ A	$I_C = 0$ $V_{EB} = 4.0$ V
h_{FE}	DC Pulse Current Gain (Note 3)	30	125	300		$I_C = 1.0$ A $V_{CE} = 2.5$ V
$V_{CEO(sus)}$	Collector to Emitter Sustaining Voltage	180			Volts	$I_C = 20$ mA $R_{BE} = \infty$
$I_{CES}(150^\circ\text{C})$	Collector Cutoff Current		0.005	1.0	mA	$V_{CE} = 200$ V $R_{BE} = 0 \Omega$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 3)		0.35	0.65	Volts	$I_C = 5.0$ A $I_B = 0.5$ A
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 3)		1.10	1.40	Volts	$I_C = 5.0$ A $I_B = 0.5$ A
C_{cb}	Collector to Base Capacitance		55	80	pF	$I_E = 0$ $V_{CB} = 50$ V
h_{fe}	High Frequency Current Gain ($f = 20$ MHz)	2.5	3.5			$I_C = 100$ mA $V_{CE} = 10$ V
t_{on}	Turn On Time		0.40	1.0	μ s	$I_C = 7.0$ A, $I_{B1} = I_{B2} = 0.7$ A
t_{stg}	Storage Time		0.50	1.5	μ s	$I_C = 7.0$ A, $I_{B1} = I_{B2} = 0.7$ A
t_f	Fall Time		0.40	1.0	μ s	$I_C = 7.0$ A, $I_{B1} = I_{B2} = \pm 0.7$ A
t_{on}	Turn On Time			1.5	μ s	$I_C = 1.0$ A, $I_{B1} = I_{B2} = 0.1$ A
t_{stg}	Storage Time			2.5	μ s	$I_C = 1.0$ A, $I_{B1} = I_{B2} = 0.1$ A
t_f	Fall Time			1.5	μ s	$I_C = 1.0$ A, $I_{B1} = I_{B2} = 0.1$ A

NOTES:

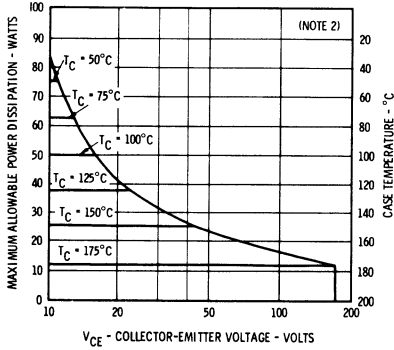
- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- (2) The maximum power dissipation rating is the greatest allowable DC power. Maximum allowable power dissipation at any operating voltage is determined from the "Forward Biased Safe Operating Area" curve.
- (3) Pulse Conditions: length = 300 μ s; duty cycle = 1%.

*Planar is a patented Fairchild process.

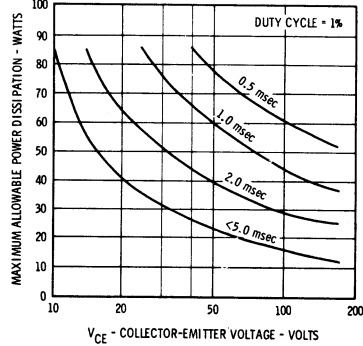
FAIRCHILD TRANSISTOR 2N5264

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DC FORWARD BIASED SAFE OPERATING AREA

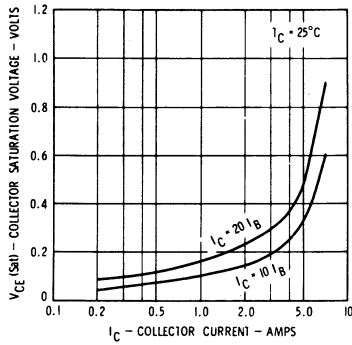


PULSED FORWARD BIASED SAFE OPERATING AREA

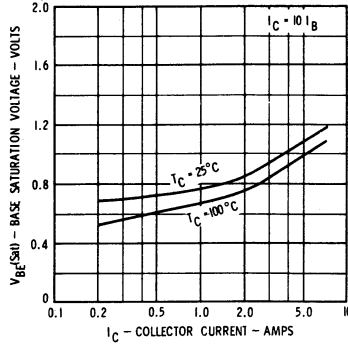


TYPICAL ELECTRICAL CHARACTERISTICS

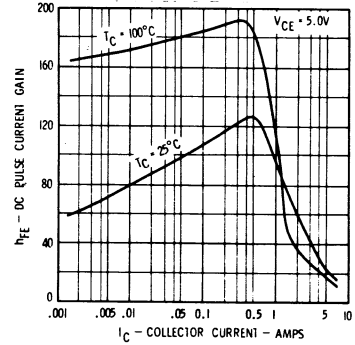
COLLECTOR SATURATION VOLTAGE VERSUS COLLECTOR CURRENT



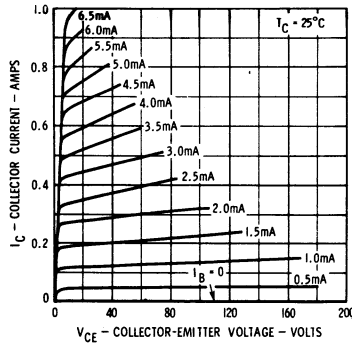
BASE SATURATION VOLTAGE VERSUS COLLECTOR CURRENT



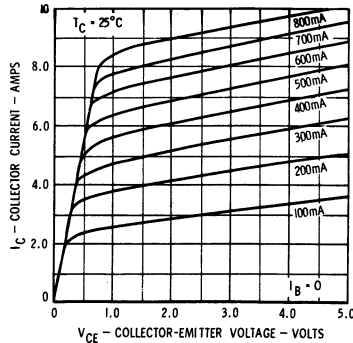
DC PULSE CURRENT GAIN VERSUS COLLECTOR CURRENT



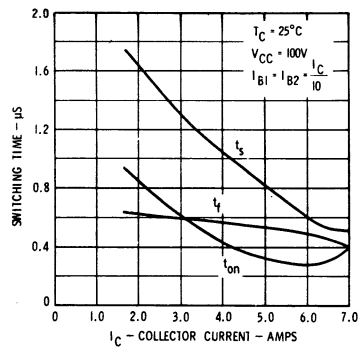
COLLECTOR CHARACTERISTICS ACTIVE REGION*



COLLECTOR CHARACTERISTICS SATURATION REGION*



SWITCHING TIME VERSUS COLLECTOR CURRENT



*Single family characteristics on Transistor Curve Tracer.

2N5284 • 2N5285

50 WATT NPN POWER TRANSISTORS

DIFFUSED SILICON PLANAR* EPITAXIAL TRANSISTORS

SEE 2N5286 • 2N5287 FOR PNP COMPLEMENT

- HIGH POWER 50 WATTS AT $T_C = 50^\circ\text{C}$, $V_{CE} = 40\text{ V}$
- HIGH VOLTAGE 100 V (MIN) LV_{CEO}
- HIGH CURRENT SATURATION VOLTAGE . . . 1.5 V (MAX) $V_{CE(sat)}$ AT 5.0 A
- HIGH FREQUENCY 60 AND 70 MHz (MIN) f_T
- BETA GUARANTEED AT 3 POINTS 50 mA, 2.5 A AND 5.0 A
- ISOLATED COLLECTOR PACKAGE NO ISOLATING HARDWARE REQUIRED
- DISCRETE EMITTER GEOMETRY WITH INTEGRATED FEEDBACK RESISTORS

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures

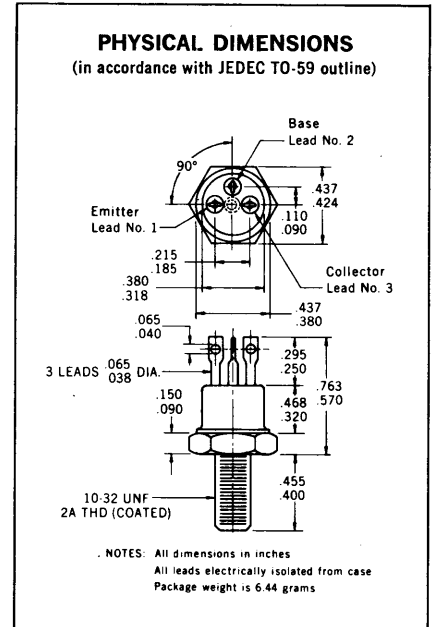
Storage Temperature -65°C to +200°C
 Operating Junction Temperature -65°C to +200°C
 Lead Temperature (Soldering, 60 seconds time limit) +300°C

Maximum Power Dissipation

Total Dissipation at 50°C Case Temperature, $V_{CE} = 40\text{ V}$ 50 Watts
 (See Maximum Permissible Power Curve and Note 4)

Maximum Voltages and Current

V_{CES} Collector to Emitter Voltage 120 Volts
 V_{CEO} Collector to Emitter Voltage (Note 2) 100 Volts
 V_{EBO} Emitter to Base Voltage 6.0 Volts
 I_C Collector Current 5.0 Amps



ELECTRICAL CHARACTERISTICS (25°C Case Temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	2N5284			2N5285			UNITS	TEST CONDITIONS
		MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
$V_{CEO(sus)}$	Collector to Emitter Sustaining Voltage (Notes 2 and 3)	100			100			Volts	$I_C = 100\text{ mA}$ $I_B = 0$
BV_{CES}	Collector to Emitter Breakdown Voltage	120			120			Volts	$I_C = 1.0\text{ mA}$ $V_{BE} = 0$
BV_{EBO}	Emitter to Base Breakdown Voltage	6.0			6.0			Volts	$I_C = 0$ $I_E = 1.0\text{ mA}$
h_{FE}	DC Pulse Current Gain (Note 3)	20	46		50	100			$I_C = 50\text{ mA}$ $V_{CE} = 5.0\text{ V}$
h_{FE}	DC Pulse Current Gain (Note 3)	30	64	90	70	114	200		$I_C = 2.5\text{ A}$ $V_{CE} = 5.0\text{ V}$
$h_{FE}(-55^\circ\text{C})$	DC Pulse Current Gain (Note 3)	15	26		35	50			$I_C = 2.5\text{ A}$ $V_{CE} = 5.0\text{ V}$
h_{FE}	DC Pulse Current Gain (Note 3)	20	53		40	65			$I_C = 5.0\text{ A}$ $V_{CE} = 5.0\text{ V}$
h_{fe}	High Frequency Current Gain ($f = 20\text{ MHz}$)	3.0	3.4		3.5	4.4			$I_C = 0.5\text{ A}$ $V_{CE} = 5.0\text{ V}$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 3)		0.43	0.75		0.43	0.75	Volts	$I_C = 2.5\text{ A}$ $I_B = 0.25\text{ A}$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 3)		0.85	1.5		0.85	1.5	Volts	$I_C = 5.0\text{ A}$ $I_B = 0.5\text{ A}$

Additional Electrical Characteristics on page 2
 Notes on page 2

*Planar is a patented Fairchild process.



FAIRCHILD TRANSISTORS 2N5284 • 2N5285

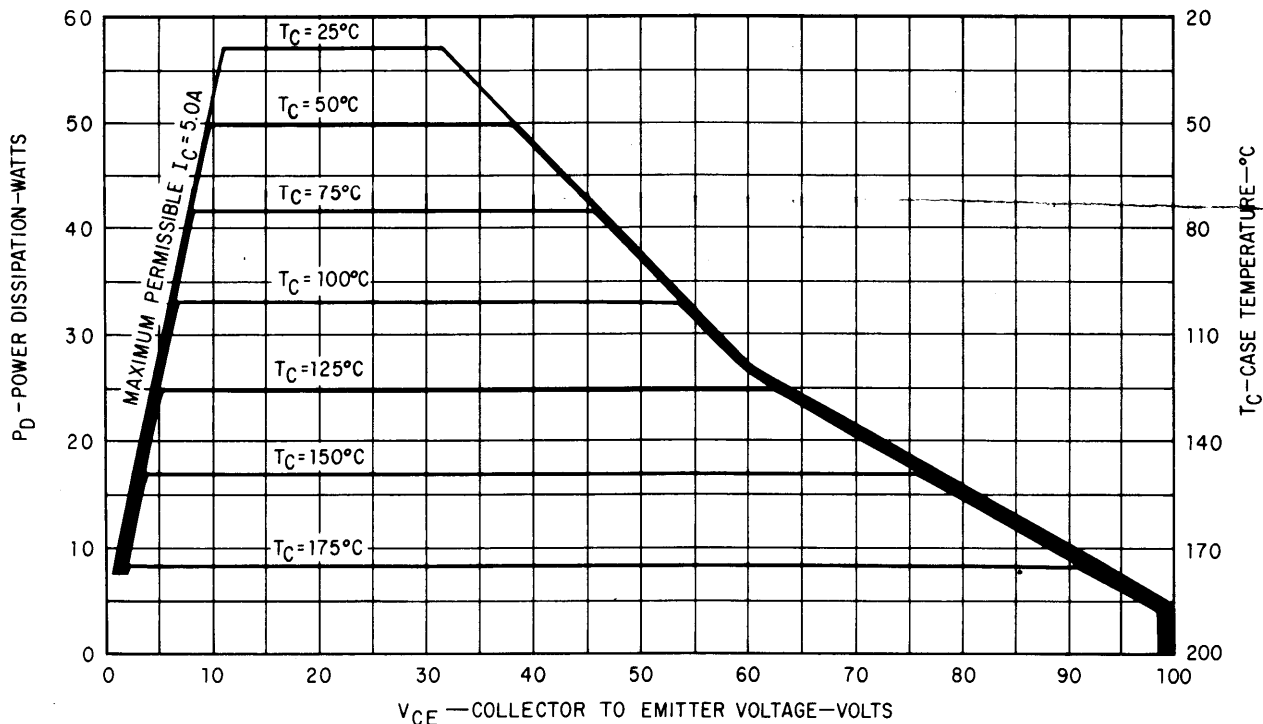
ELECTRICAL CHARACTERISTICS (25°C Case Temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	2N5284			2N5285			UNITS	TEST CONDITIONS	
		MIN.	TYP.	MAX.	MIN.	TYP.	MAX.			
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 3)		1.16	1.45	1.16	1.45		Volts	$I_C = 2.5 \text{ A}$	$I_B = 0.25 \text{ A}$
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 3)		1.50	2.2	1.50	2.2		Volts	$I_C = 5.0 \text{ A}$	$I_B = 0.5 \text{ A}$
$V_{BE(on)}$	Pulsed Base Emitter "ON" Voltage (Note 3)			1.45		1.45		Volts	$I_C = 2.5 \text{ A}$	$V_{CE} = 5.0 \text{ V}$
I_{CES}	Collector Cutoff Current	0.007		1.0	0.007		1.0	μA	$V_{CE} = 80 \text{ V}$	$V_{BE} = 0$
I_{CEO}	Collector Cutoff Current			50			50	μA	$I_B = 0$	$V_{CE} = 60 \text{ V}$
I_{EBO}	Emitter Cutoff Current			1.0			1.0	μA	$I_C = 0$	$V_{EB} = 5.0 \text{ V}$
$I_{CEX}(150^\circ\text{C})$	Collector Reverse Current			500			500	μA	$V_{CE} = 80 \text{ V}$	$V_{EB} = 2.0 \text{ V}$
C_{cb}	Collector to Base Capacitance		90	250		90	250	pF	$I_E = 0$	$V_{CB} = 10 \text{ V}$
h_{ie}	Small Signal Current Gain ($f = 1.0 \text{ kHz}$)	20			20				$I_C = 100 \text{ mA}$	$V_{CE} = 5.0 \text{ V}$

NOTES:

- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- (2) This rating refers to a high current point where collector to emitter voltage is lowest.
- (3) Pulse Conditions: length = 300 μs ; duty cycle = 1%.
- (4) Contact factory for maximum permissible power under pulsed or reverse biased operating conditions.

MAXIMUM PERMISSIBLE DC FORWARD BIASED POWER DISSIPATION



2N5286 • 2N5287

50 WATT PNP POWER TRANSISTORS

DIFFUSED SILICON PLANAR* EPITAXIAL TRANSISTORS

SEE 2N5284 • 2N5285 FOR NPN COMPLEMENT

FEATURES

- HIGH POWER 50 WATTS AT $T_C = 50^\circ\text{C}$, $V_{CE} = -40\text{ V}$
- HIGH VOLTAGE $-100\text{ V (MIN) } V_{CEO}$
- HIGH CURRENT SATURATION VOLTAGE . . . $-1.5\text{ V (MAX) } V_{CE(sat)}$ AT 5.0 A
- HIGH FREQUENCY 60 AND 70 MHz (MIN) f_T
- BETA GUARANTEED AT 3 POINTS 50 mA, 2.5 A AND 5.0 A
- ISOLATED COLLECTOR PACKAGE NO ISOLATING HARDWARE REQUIRED
- DISCRETE EMITTER GEOMETRY WITH INTEGRATED FEEDBACK RESISTORS

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures

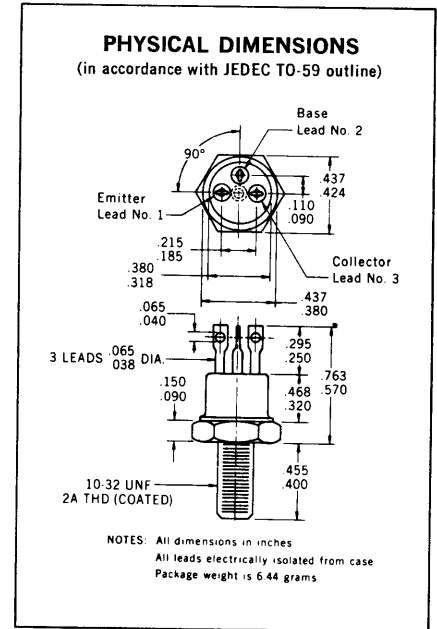
- Storage Temperature $-65^\circ\text{C to } +200^\circ\text{C}$
- Operating Junction Temperature $-65^\circ\text{C to } +200^\circ\text{C}$
- Lead Temperature (Soldering, 60 seconds time limit) $+300^\circ\text{C}$

Maximum Power Dissipation

- Total Dissipation at 50°C Case Temperature, $V_{CE} = -40\text{ V}$ 50 Watts
- (See Maximum Permissible Power Curve and Note 4)

Maximum Voltages and Current

- V_{CES} Collector to Emitter Voltage -100 Volts
- V_{CEO} Collector to Emitter Voltage (Note 2) -100 Volts
- V_{EBO} Emitter to Base Voltage -5.5 Volts
- I_C Collector Current 5.0 Amps



ELECTRICAL CHARACTERISTICS (25°C Case Temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	2N5286			2N5287			UNITS	TEST CONDITIONS
		MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
$V_{CEO(sus)}$	Collector to Emitter Sustaining Voltage (Notes 2 and 3)	-100			-100			Volts	$I_C = 100\text{ mA}$ $I_B = 0$
BV_{CES}	Collector to Emitter Breakdown Voltage	-100			-100			Volts	$I_C = 1.0\text{ mA}$ $V_{BE} = 0$
BV_{EBO}	Emitter to Base Breakdown Voltage	-5.5			-5.5			Volts	$I_C = 0$ $I_E = 1.0\text{ mA}$
h_{FE}	DC Pulse Current Gain (Note 3)	20	52		50	130			$I_C = 50\text{ mA}$ $V_{CE} = -5.0\text{ V}$
h_{FE}	DC Pulse Current Gain (Note 3)	30	50	90	70	114	200		$I_C = 2.5\text{ A}$ $V_{CE} = -5.0\text{ V}$
$h_{FE}(-55^\circ\text{C})$	DC Pulse Current Gain (Note 3)	15	32		35	90			$I_C = 2.5\text{ A}$ $V_{CE} = -5.0\text{ V}$
h_{FE}	DC Pulse Current Gain (Note 3)	20	38		40	77			$I_C = 5.0\text{ A}$ $V_{CE} = -5.0\text{ V}$
h_{fe}	High Frequency Current Gain ($f = 20\text{ MHz}$)	3.0	4.05		3.5	4.85			$I_C = 0.5\text{ A}$ $V_{CE} = -5.0\text{ V}$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 3)		-0.45	-0.75		-0.45	-0.75	Volts	$I_C = 2.5\text{ A}$ $I_B = 0.25\text{ A}$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 3)		-0.9	-1.5		-0.9	-1.5	Volts	$I_C = 5.0\text{ A}$ $I_B = 0.5\text{ A}$

Additional Electrical Characteristics on Page 2
Notes on Page 2

*Planar is a patented Fairchild process.



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FAIRCHILD TRANSISTORS 2N5286 • 2N5287

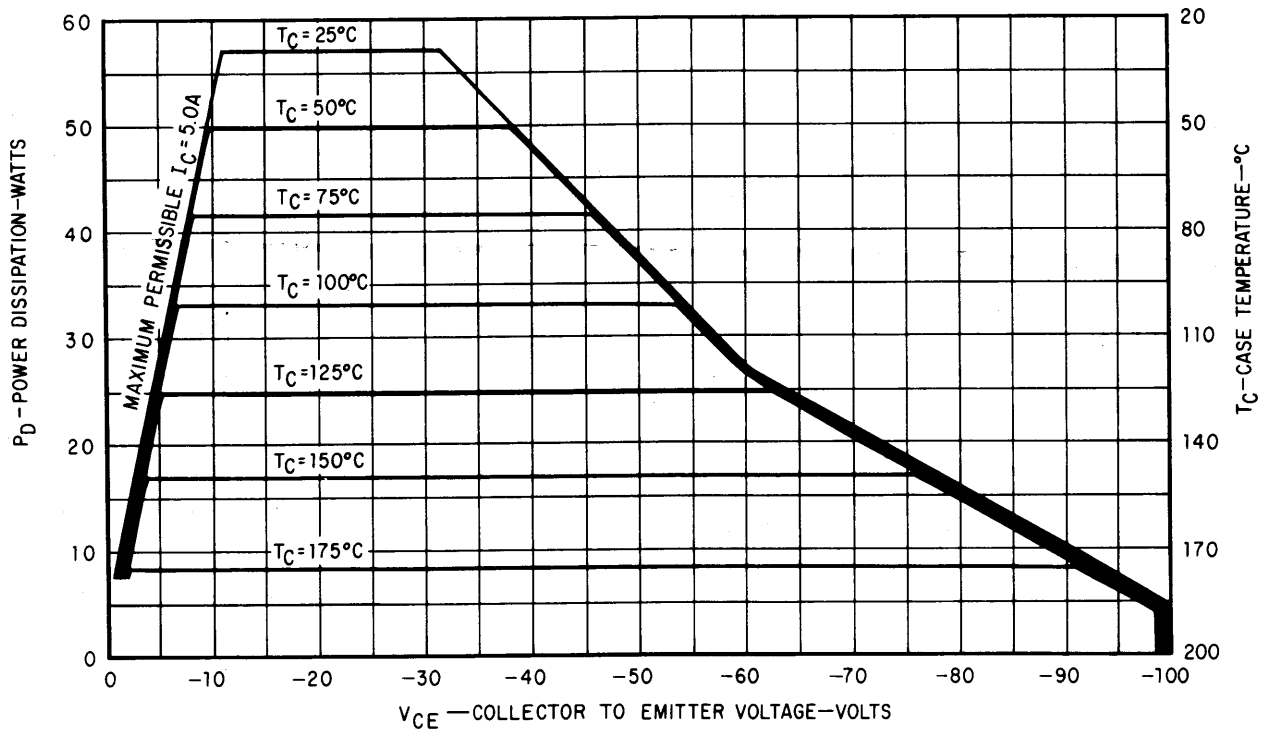
ELECTRICAL CHARACTERISTICS (25°C Case Temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	2N5286			2N5287			UNITS	TEST CONDITIONS
		MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 3)	-1.1	-1.45		-1.1	-1.45		Volts	$I_C = 2.5 \text{ A}$ $I_B = 0.25 \text{ A}$
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 3)	-1.55	-2.2		-1.55	-2.2		Volts	$I_C = 5.0 \text{ A}$ $I_B = 0.5 \text{ A}$
$V_{BE(on)}$	Pulsed Base Emitter "ON" Voltage (Note 3)		-1.45			-1.45		Volts	$I_C = 2.5 \text{ A}$ $V_{CE} = -5.0 \text{ V}$
I_{CES}	Collector Cutoff Current	0.006	1.0		0.006	1.0		μA	$V_{CE} = -80 \text{ V}$ $V_{BE} = 0$
I_{CEO}	Collector Cutoff Current		50			50		μA	$I_B = 0$ $V_{CE} = -60 \text{ V}$
I_{EBO}	Emitter Cutoff Current		1.0			1.0		μA	$I_C = 0$ $V_{BE} = 4.0 \text{ V}$
$I_{CEX}(150^\circ\text{C})$	Collector Reverse Current		500			500		μA	$V_{CE} = -80 \text{ V}$ $V_{BE} = 2.0 \text{ V}$
C_{cb}	Collector to Base Capacitance		170	250		170	250	pF	$I_E = 0$ $V_{CB} = -10 \text{ V}$
h_{fe}	Small Signal Current Gain ($f = 1.0 \text{ kHz}$)	20			20				$I_C = 100 \text{ mA}$ $V_{CE} = -5.0 \text{ V}$

NOTES:

- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- (2) This rating refers to a high current point where collector to emitter voltage is lowest.
- (3) Pulse Conditions: length = 300 μs ; duty cycle = 1%.
- (4) Contact factory for maximum permissible power under pulsed or reverse biased operating conditions.

MAXIMUM PERMISSIBLE DC FORWARD BIASED POWER DISSIPATION



2N5288 • 2N5289

100 WATT NPN POWER TRANSISTORS

DIFFUSED SILICON PLANAR* EPITAXIAL TRANSISTORS

SEE 2N5290 • 2N5291 FOR PNP COMPLEMENT

- HIGH POWER 100 WATTS AT $T_C = 50^\circ\text{C}$, $V_{CE} = 40\text{ V}$
- HIGH VOLTAGE 100 V (MIN) V_{CEO}
- HIGH CURRENT SATURATION VOLTAGE . . . 1.5 V (MAX) $V_{CE(sat)}$ AT 10 A
- HIGH FREQUENCY 30 AND 40 MHz (MIN) f_T
- BETA GUARANTEED AT 3 POINTS 100 mA, 5.0 A AND 10 A
- ISOLATED COLLECTOR PACKAGE NO ISOLATING HARDWARE REQUIRED
- DISCRETE EMITTER GEOMETRY WITH INTEGRATED FEEDBACK RESISTORS

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures

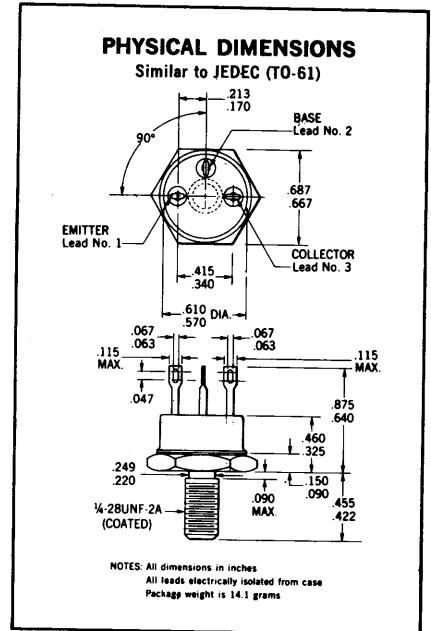
- Storage Temperature -65°C to $+200^\circ\text{C}$
- Operating Junction Temperature -65°C to $+200^\circ\text{C}$
- Lead Temperature (Soldering, 60 seconds time limit) $+300^\circ\text{C}$

Maximum Power Dissipation

- Total Dissipation at 50°C Case Temperature, $V_{CE} = 40\text{ V}$ **100 Watts**
- (See Maximum Permissible Power Curve and Note 4)

Maximum Voltages and Current

- V_{CES} Collector to Emitter Voltage 120 Volts
- V_{CEO} Collector to Emitter Voltage (Note 2) 100 Volts
- V_{EBO} Emitter to Base Voltage 6.0 Volts
- I_C Collector Current 10 Amps



ELECTRICAL CHARACTERISTICS (25°C Case Temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	2N5288		2N5289		UNITS	TEST CONDITIONS
		MIN.	MAX.	MIN.	MAX.		
$V_{CEO(sus)}$	Collector to Emitter Sustaining Voltage (Notes 2 and 3)	100		100		Volts	$I_C = 200\text{ mA}$ $I_B = 0$
BV_{CES}	Collector to Emitter Breakdown Voltage	120		120		Volts	$I_C = 1.0\text{ mA}$ $V_{BE} = 0$
BV_{EBO}	Emitter to Base Breakdown Voltage	6.0		6.0		Volts	$I_C = 0$ $I_E = 1.0\text{ mA}$
h_{FE}	DC Pulse Current Gain (Note 3)	20		50			$I_C = 100\text{ mA}$ $V_{CE} = 5.0\text{ V}$
h_{FE}	DC Pulse Current Gain (Note 3)	30	90	70	200		$I_C = 5.0\text{ A}$ $V_{CE} = 5.0\text{ V}$
$h_{FE}(-55^\circ\text{C})$	DC Pulse Current Gain (Note 3)	12		35			$I_C = 5.0\text{ A}$ $V_{CE} = 5.0\text{ V}$
h_{FE}	DC Pulse Current Gain (Note 3)	20		45			$I_C = 10\text{ A}$ $V_{CE} = 5.0\text{ V}$
h_{fe}	High Frequency Current Gain ($f = 20\text{ MHz}$)	1.5		2.0			$I_C = 2.0\text{ A}$ $V_{CE} = 5.0\text{ V}$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 3)		0.9		0.9	Volts	$I_C = 5.0\text{ A}$ $I_B = 0.5\text{ A}$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 3)		1.5		1.5	Volts	$I_C = 10\text{ A}$ $I_B = 1.0\text{ A}$

Additional Electrical Characteristics on page 2

*Planar is a patented Fairchild process.

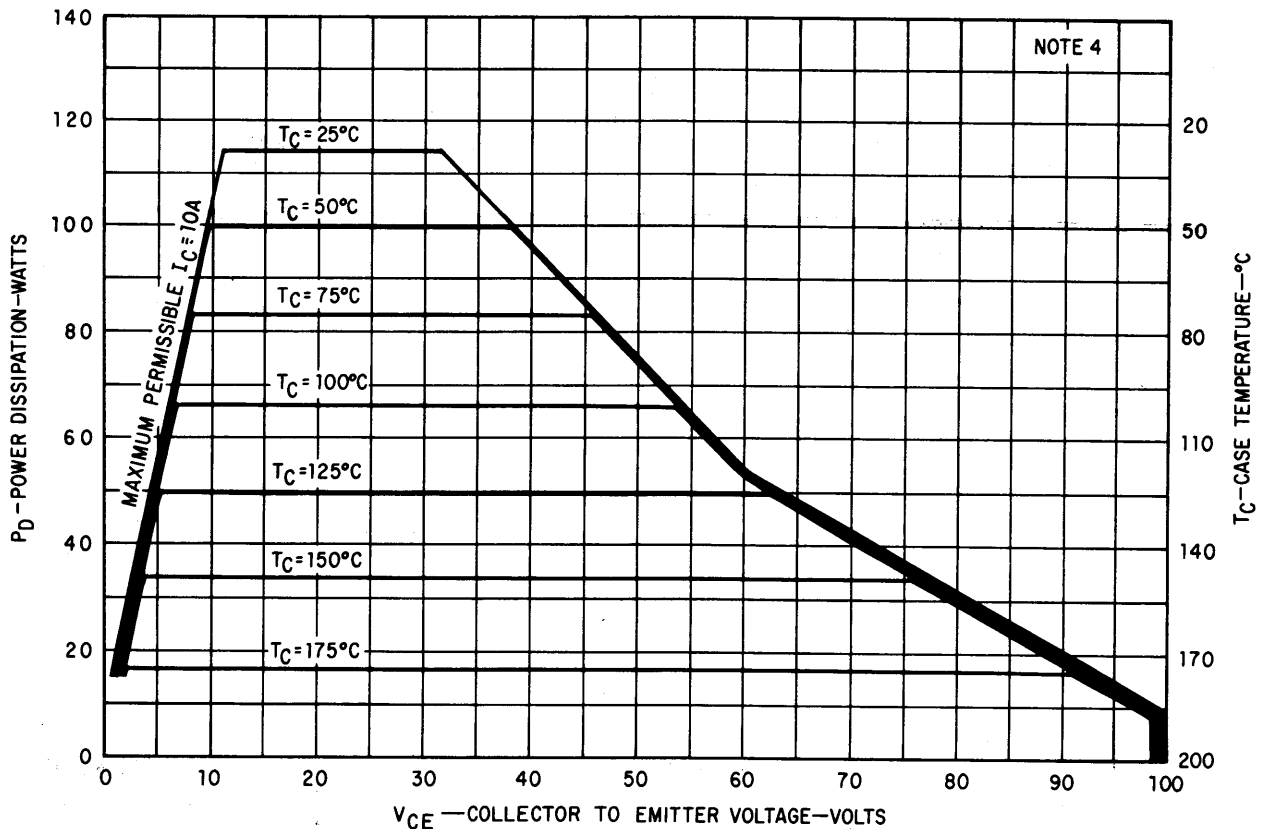
FAIRCHILD TRANSISTORS 2N5288 • 2N5289

ELECTRICAL CHARACTERISTICS (25°C Case Temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	2N5288		2N5289		UNITS	TEST CONDITIONS	
		MIN.	MAX.	MIN.	MAX.			
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 3)		1.8	1.8		Volts	$I_C = 5.0 \text{ A}$	$I_B = 0.5 \text{ A}$
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 3)		2.2	2.2		Volts	$I_C = 10 \text{ A}$	$I_B = 1.0 \text{ A}$
$V_{BE(on)}$	Pulsed Base Emitter "ON" Voltage (Note 3)		1.8	1.8		Volts	$I_C = 5.0 \text{ A}$	$V_{CE} = 5.0 \text{ V}$
I_{CES}	Collector Cutoff Current		1.0	1.0		μA	$V_{CE} = 80 \text{ V}$	$V_{BE} = 0$
I_{EBO}	Emitter Cutoff Current		1.0	1.0		μA	$I_C = 0$	$V_{EB} = 5.0 \text{ V}$
$I_{CEX(150^\circ\text{C})}$	Collector Reverse Current		500	500		μA	$V_{CE} = 80 \text{ V}$	$V_{EB} = 2.0 \text{ V}$
C_{cb}	Collector to Base Capacitance		275	275		pF	$I_E = 0$	$V_{CB} = 10 \text{ V}$
I_{CES}	Collector Cutoff Current		1.0	1.0		mA	$V_{CE} = 120 \text{ V}$	$V_{BE} = 0$
I_{EBO}	Emitter Cutoff Current		1.0	1.0		mA	$I_C = 0$	$V_{EB} = 6.0 \text{ V}$
I_{CEO}	Collector Cutoff Current		50	50		μA	$I_B = 0$	$V_{CE} = 60 \text{ V}$
h_{fe}	Small Signal Current Gain ($f = 1.0 \text{ kHz}$)	20		50			$I_C = 200 \text{ mA}$	$V_{CE} = 5.0 \text{ V}$

- NOTES:**
- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
 - (2) This rating refers to a high current point where collector to emitter voltage is lowest.
 - (3) Pulse Conditions: length = 300 μs ; duty cycle = 1%.
 - (4) Contact factory for maximum permissible power under pulsed or reverse biased operating conditions.

MAXIMUM PERMISSIBLE DC FORWARD BIASED POWER DISSIPATION



2N5290 • 2N5291

100 WATT PNP POWER TRANSISTORS

DIFFUSED SILICON PLANAR* EPITAXIAL TRANSISTORS

SEE 2N5288 • 2N5289 FOR NPN COMPLEMENT

- HIGH POWER 100 WATTS AT $T_C = 50^\circ\text{C}$, $V_{CE} = -40\text{ V}$
- HIGH VOLTAGE $-100\text{ V (MIN) } V_{CEO}$
- HIGH CURRENT SATURATION VOLTAGE . . . 1.5 V (MAX) $V_{CE(sat)}$ AT 10 A
- HIGH FREQUENCY 30 AND 40 MHz (MIN) f_T
- BETA GUARANTEED AT 3 POINTS 100 mA, 5.0 A AND 10 A
- ISOLATED COLLECTOR PACKAGE NO ISOLATING HARDWARE REQUIRED
- DISCRETE EMITTER GEOMETRY WITH INTEGRATED FEEDBACK RESISTORS

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures

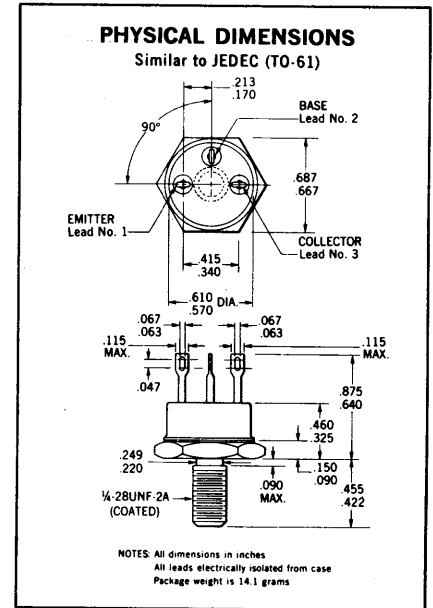
- Storage Temperature $-65^\circ\text{C to } +200^\circ\text{C}$
- Operating Junction Temperature $-65^\circ\text{C to } +200^\circ\text{C}$
- Lead Temperature (Soldering, 60 seconds time limit) $+300^\circ\text{C}$

Maximum Power Dissipation

- Total Dissipation at 50°C Case Temperature, $V_{CE} = -40\text{ V}$ **100 Watts**
- (See Maximum Permissible Power Curve and Note 4)

Maximum Voltages and Current

- V_{CES} Collector to Emitter Voltage -100 Volts
- V_{CEO} Collector to Emitter Voltage (Note 2) -100 Volts
- V_{EBO} Emitter to Base Voltage -5.5 Volts
- I_C Collector Current **10 Amps**



ELECTRICAL CHARACTERISTICS (25°C Case Temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	2N5290		2N5291		UNITS	TEST CONDITIONS
		MIN.	MAX.	MIN.	MAX.		
$V_{CEO(sus)}$	Collector to Emitter Sustaining Voltage (Notes 2 and 3)	-100		-100		Volts	$I_C = 200\text{ mA}$ $I_B = 0$
BV_{CES}	Collector to Emitter Breakdown Voltage	-100		-100		Volts	$I_C = 1.0\text{ mA}$ $V_{BE} = 0$
BV_{EBO}	Emitter to Base Breakdown Voltage	-5.5		-5.5		Volts	$I_C = 0$ $I_E = 1.0\text{ mA}$
h_{FE}	DC Pulse Current Gain (Note 3)	20		50			$I_C = 100\text{ mA}$ $V_{CE} = -5.0\text{ V}$
h_{FE}	DC Pulse Current Gain (Note 3)	30	90	70	200		$I_C = 5.0\text{ A}$ $V_{CE} = -5.0\text{ V}$
$h_{FE}(-55^\circ\text{C})$	DC Pulse Current Gain (Note 3)	12		35			$I_C = 5.0\text{ A}$ $V_{CE} = -5.0\text{ V}$
h_{FE}	DC Pulse Current Gain (Note 3)	20		45			$I_C = 10\text{ A}$ $V_{CE} = -5.0\text{ V}$
h_{fe}	High Frequency Current Gain ($f = 20\text{ MHz}$)	1.5		2.0			$I_C = 2.0\text{ A}$ $V_{CE} = -5.0\text{ V}$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 3)		-0.9		-0.9	Volts	$I_C = 5.0\text{ A}$ $I_B = 0.5\text{ A}$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 3)		-1.5		-1.5	Volts	$I_C = 10\text{ A}$ $I_B = 1.0\text{ A}$

Additional Electrical Characteristics on page 2

*Planar is a patented Fairchild process.



2N5292

RADIATION RESISTANT, PNP HIGH SPEED SATURATED SWITCH

DIFFUSED SILICON PLANAR* II EPITAXIAL TRANSISTOR

- GUARANTEED PERFORMANCE AFTER NEUTRON IRRADIATION OF 3×10^{14} nvt > 10 keV
- FAST SWITCHING $t_{on} = 25$ ns (MAX) AFTER RADIATION
 $t_{off} = 35$ ns (MAX) AFTER RADIATION
- HIGH FREQUENCY $f_T = 600$ MHz (MIN) AFTER RADIATION
- LOW CAPACITANCE $C_{cb} = 4.5$ pF (MAX) AFTER RADIATION
- LOW SATURATION VOLTAGE . . . $V_{CE(sat)} = -0.65$ V (MAX) AT $I_C = 100$ mA AFTER RADIATION

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures

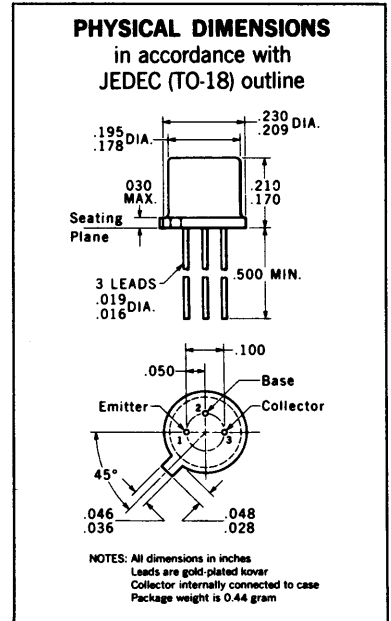
Storage Temperature	-65°C to +200°C
Operating Junction Temperature	200°C
Lead Temperature (Soldering, 60 second time limit)	300°C

Maximum Power Dissipation (Notes 2 and 3)

Total Dissipation at 25°C Case Temperature	1.0 Watts
at 100°C Case Temperature	0.72 Watt
at 25°C Ambient Temperature	0.36 Watt

Maximum Voltages

V_{CBO} Collector to Base Voltage	-12 Volts
V_{CEO} Collector to Emitter Voltage (Note 4)	-12 Volts
V_{EBO} Emitter to Base Voltage	-4.5 Volts



ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

SYMBOL	CHARACTERISTICS	PRE-IRRADIATION			POST-IRRADIATION (3×10^{14} nvt > 10 keV)			UNITS	TEST CONDITIONS		
		MIN.	TYP.	MAX.	MIN.	TYP.	MAX.				
t_{on}	Turn On Time (Note 5, Figure 1)		6.0	15	8.0	25	ns	$I_C \approx 30$ mA	$I_{B1} \approx 6.0$ mA		
t_{off}	Turn Off Time (Note 5, Figure 1)		18	35	15	35	ns	$I_C \approx 30$ mA	$I_{B1} \approx 6.0$ mA		
τ_s	Charge Storage Time Constant (Note 6, Figure 2)		15	20	5.0	20	ns	$I_C \approx 10$ mA	$I_{B2} \approx -6.0$ mA $I_{B1} \approx 10$ mA $I_{B2} \approx -10$ mA		
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 6)		-0.06	-0.12	-0.113	-0.24	Volts	$I_C = 10$ mA	$I_B = 2.0$ mA		
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 6)		-0.12	-0.19	-0.212	-0.4	Volts	$I_C = 30$ mA	$I_B = 6.0$ mA		
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 6)		-0.28	-0.44	-0.367	-0.65	Volts	$I_C = 100$ mA	$I_B = 20$ mA		
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 6)		-0.78	-0.82	-0.92	-0.78	-0.83	-0.95	Volts	$I_C = 10$ mA	$I_B = 2.0$ mA
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 6)		-0.85	-0.93	-1.2	-0.85	-0.93	-1.2	Volts	$I_C = 30$ mA	$I_B = 6.0$ mA
$V_{BE(sat)}$	Pulsed Base Saturation Voltage		-1.0	-1.14	-1.6	-1.0	-1.14	-1.75	Volts	$I_C = 100$ mA	$I_B = 20$ mA
h_{fe}	High Frequency Current Gain (f = 100 MHz)		8.0	12	6.0	10		$I_C = 30$ mA	$V_{CE} = -10$ V		
C_{cb}	Collector to Base Capacitance (f = 1.0 MHz)			2.2	4.5	2.2	4.5	pF	$I_E = 0$	$V_{CB} = -5.0$ V	
C_{eb}	Emitter to Base Capacitance (f = 1.0 MHz)			4.0	6.0	4.0	6.0	pF	$I_C = 0$	$V_{EB} = -0.5$ V	
h_{FE}	DC Pulse Current Gain (Note 6)		30	53	6.0	12.4		$I_C = 10$ mA	$V_{CE} = -0.3$ V		
h_{FE}	DC Pulse Current Gain (Note 6)		40	63	100	10	15.2		$I_C = 30$ mA	$V_{CE} = -0.5$ V	
h_{FE}	DC Pulse Current Gain (Note 6)		30	55		8.0	13.9		$I_C = 100$ mA	$V_{CE} = -1.0$ V	
$h_{FE}(-55^\circ\text{C})$	DC Pulse Current Gain (Note 6)		20	38		5.0	8.6		$I_C = 30$ mA	$V_{CE} = -0.5$ V	
I_{CES}	Collector Reverse Current			0.05	1.0	0.3	10	nA	$V_{BE} = 0$	$V_{CE} = -10$ V	
$I_{CES}(125^\circ\text{C})$	Collector Reverse Current			0.01	10	0.5	20	μ A	$V_{BE} = 0$	$V_{CE} = -10$ V	
$V_{CEO(sus)}$	Collector to Emitter Sustaining Voltage (Notes 4 and 6)		-12	-16		-12	-17.7	Volts	$I_C = 10$ mA	$I_B = 0$	
BV_{CBO}	Collector to Base Breakdown Voltage		-12	-24		-12	-24.3	Volts	$I_C = 10$ μ A	$I_E = 0$	
BV_{CES}	Collector to Emitter Breakdown Voltage		-12	-23		-12	-23.3	Volts	$I_C = 10$ μ A	$V_{BE} = 0$	
BV_{EBO}	Emitter to Base Breakdown Voltage		-4.5	-5.4		-4.5	-5.4	Volts	$I_C = 0$	$I_E = 100$ μ A	

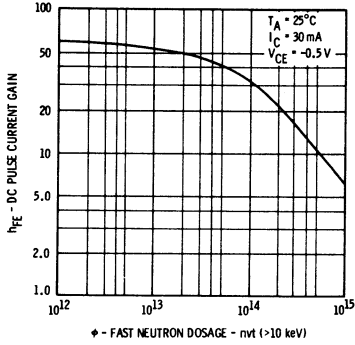
*Fairchild is a patented Fairchild process.



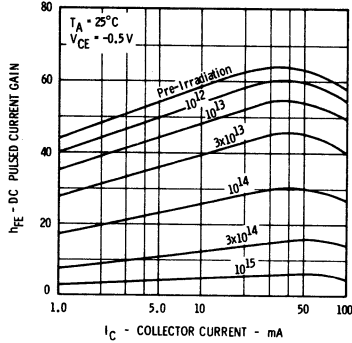
FAIRCHILD TRANSISTOR 2N5292

TYPICAL ELECTRICAL CHARACTERISTICS

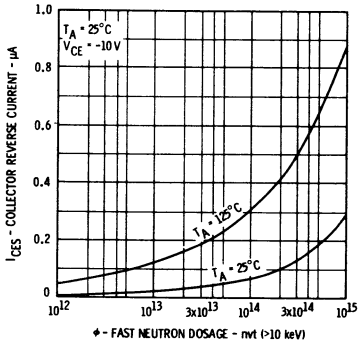
**DC PULSE CURRENT GAIN
VERSUS FAST NEUTRON DOSAGE**



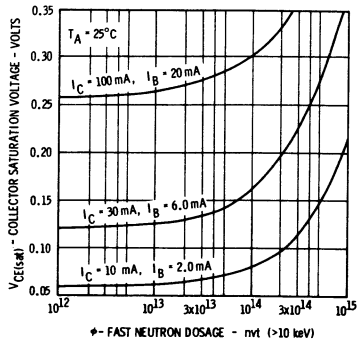
**DC PULSE CURRENT GAIN
VERSUS COLLECTOR CURRENT
FAST NEUTRON DOSAGE**



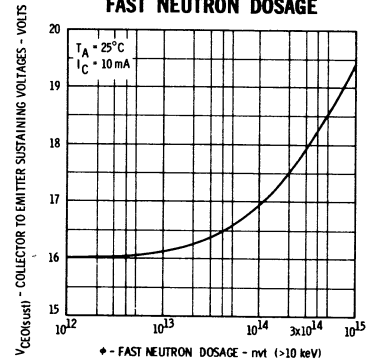
**COLLECTOR TO EMITTER CURRENT
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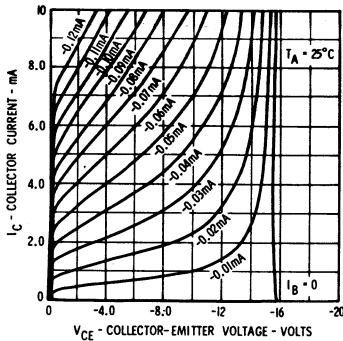
**COLLECTOR SATURATION VOLTAGE
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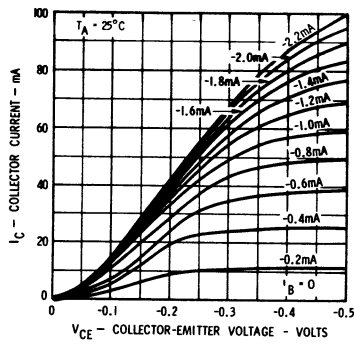
**COLLECTOR TO EMITTER
SUSTAINING VOLTAGE VERSUS
FAST NEUTRON DOSAGE**



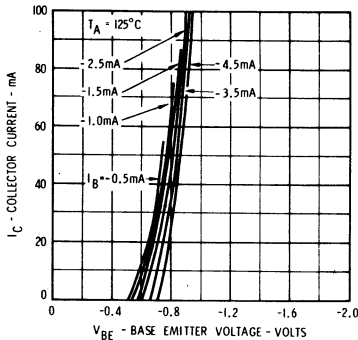
COLLECTOR CHARACTERISTICS*



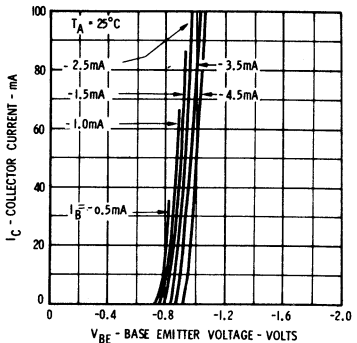
COLLECTOR CHARACTERISTICS*



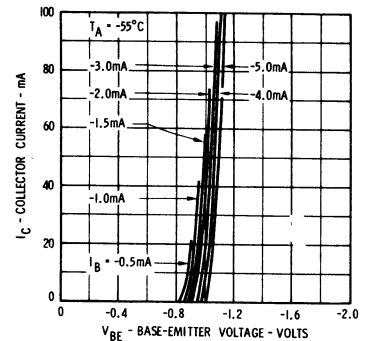
BASE CHARACTERISTIC*



BASE CHARACTERISTIC*



BASE CHARACTERISTIC*

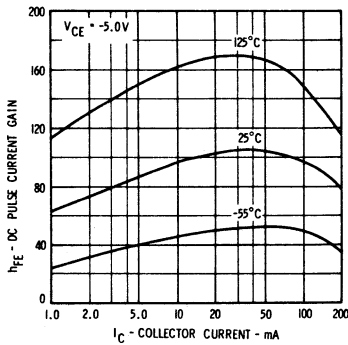


*Single family characteristics on Transistor Curve Tracer.

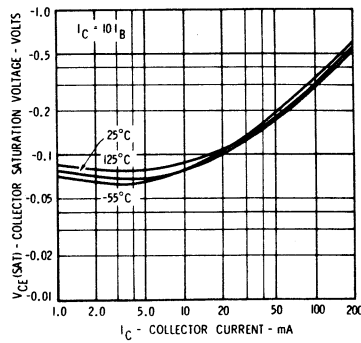
FAIRCHILD TRANSISTOR 2N5292

TYPICAL ELECTRICAL CHARACTERISTICS

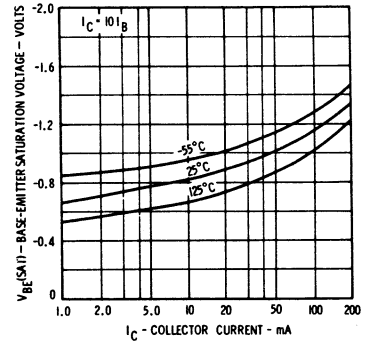
DC PULSE CURRENT GAIN VERSUS COLLECTOR CURRENT



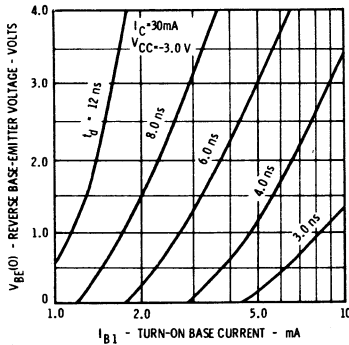
COLLECTOR SATURATION VOLTAGE VERSUS COLLECTOR CURRENT



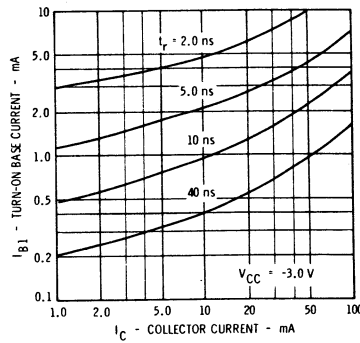
BASE SATURATION VOLTAGE VERSUS COLLECTOR CURRENT



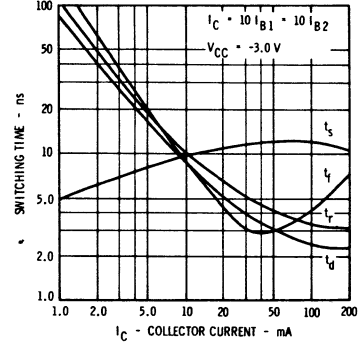
DELAY TIME VERSUS TURN ON BASE CURRENT AND REVERSE BASE EMITTER VOLTAGE



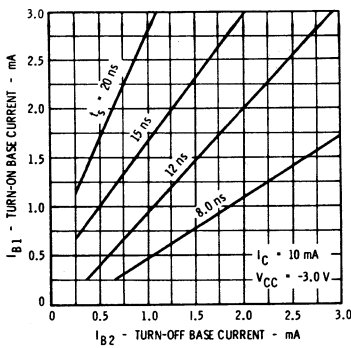
RISE TIME VERSUS COLLECTOR AND TURN ON BASE CURRENTS



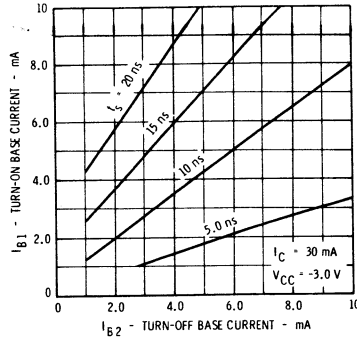
SWITCHING TIMES VERSUS COLLECTOR CURRENT



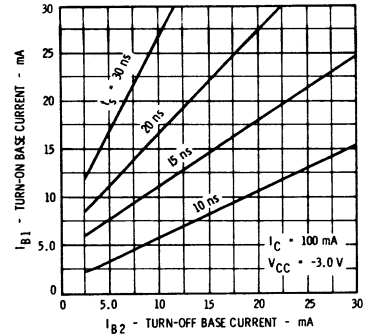
STORAGE TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



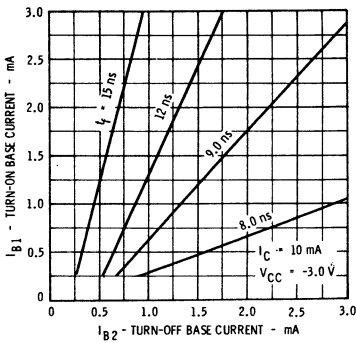
STORAGE TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



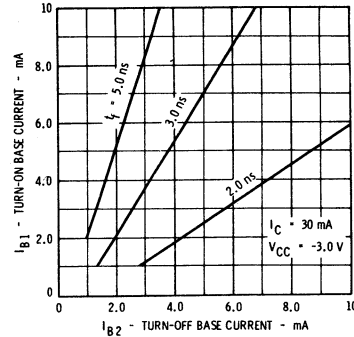
STORAGE TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



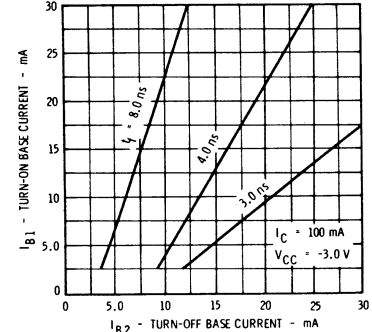
FALL TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



FALL TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



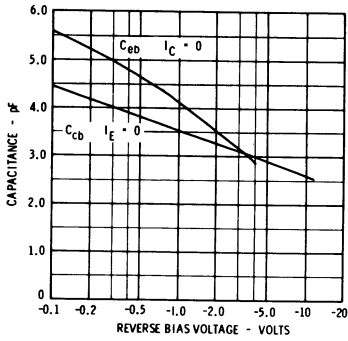
FALL TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



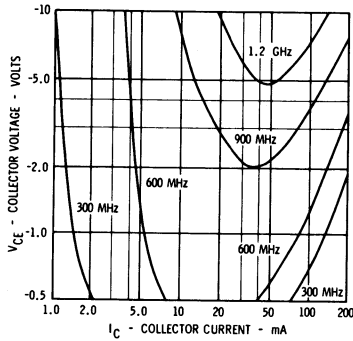
FAIRCHILD TRANSISTOR 2N5292

TYPICAL ELECTRICAL CHARACTERISTICS

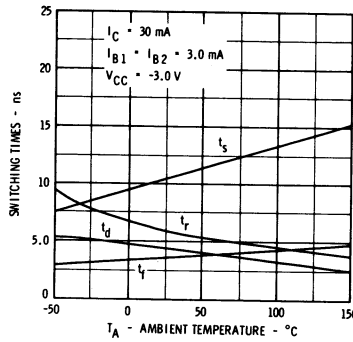
INPUT AND OUTPUT CAPACITANCE VERSUS REVERSE BIAS VOLTAGE



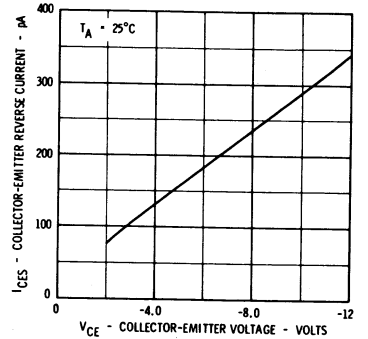
CONTOURS OF CONSTANT GAIN BANDWIDTH PRODUCT (f_T)



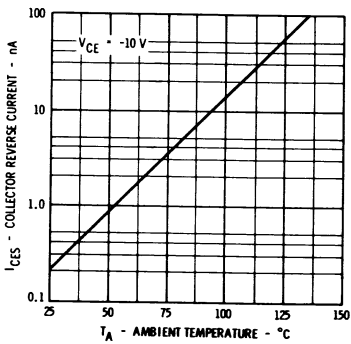
SWITCHING TIMES VERSUS TEMPERATURE



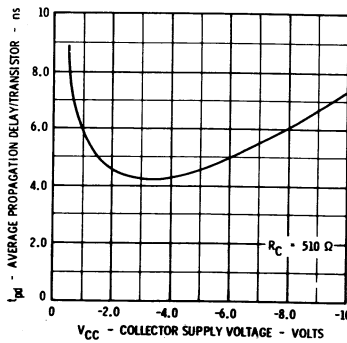
COLLECTOR-EMITTER REVERSE CURRENT VERSUS REVERSE BIAS VOLTAGE



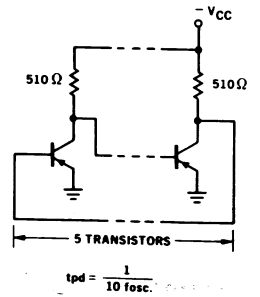
COLLECTOR REVERSE CURRENT VERSUS TEMPERATURE



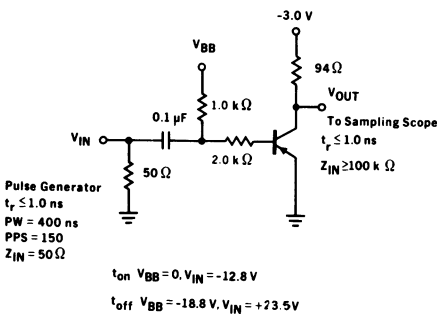
AVERAGE PROPAGATION DELAY PER TRANSISTOR VERSUS COLLECTOR VOLTAGE



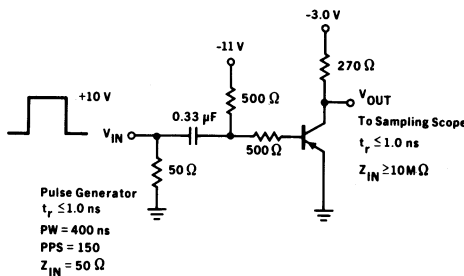
FIVE STAGE RING OSCILLATOR FOR MEASUREMENT OF PROPAGATION DELAY



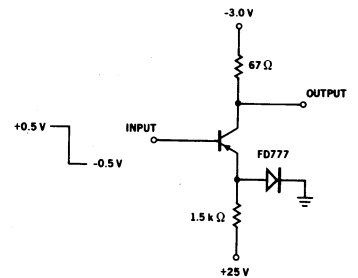
SWITCHING TIME TEST CIRCUIT FIGURE 1



STORAGE TIME TEST CIRCUIT FIGURE 2



NON SATURATED SWITCHING PERFORMANCE



NOTES:

- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- (2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- (3) These ratings give a maximum junction temperature of 200°C and junction to case thermal resistance of 486°C/Watt (derating factor of 2.06 mW/°C).
- (4) This rating refers to a high current point where collector to emitter voltage is lowest.
- (5) See switching circuit for exact values of I_C , I_{B1} , and I_{B2} .
- (6) Pulse Conditions: length = 300 μ s; duty cycle = 1%.